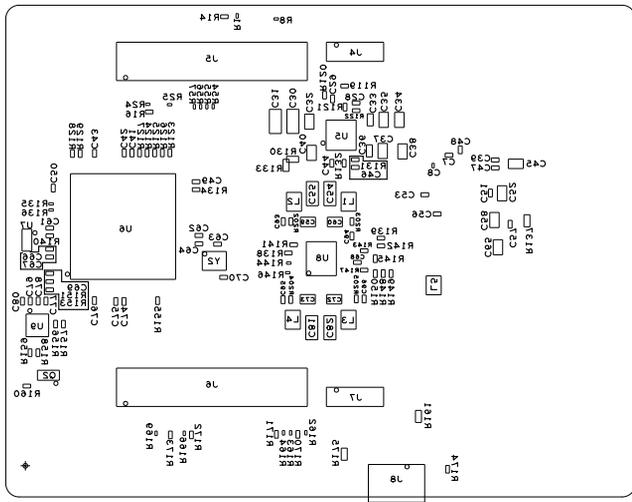


	TEXAS INSTRUMENTS	
	ASSEMBLY TOP	1642-EVM Rev-A
	DATE : 02/MARCH/2017	



 <b>TEXAS INSTRUMENTS</b>	<b>TEXAS INSTRUMENTS</b>	
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